

MOSFET

OptiMOS[™] 6 Power-Transistor, 135 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Excellent gate charge x R_{DS(on)} product (FOM) Very low reverse recovery charge (Q_{rr})
- 100% avalanche testedg
- 175°C operating temperature
- Optimized for motor drives and battery powered applications
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

- MSL 1 classified according to J-STD-020

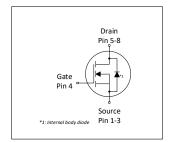


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

| Parameter | Value | Unit |
|---------------------------|-------|------|
| $V_{	extsf{DS}}$ | 135 | V |
| $R_{	extsf{DS(on),max}}$ | 4.6 | mΩ |
| I _D | 142 | A |
| Qoss | 112 | nC |
| Q _G (0V10V) | 65 | nC |
| Q _{rr} (500A/μs) | 85 | nC |











| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|------------|----------|---------------|
| ISC046N13NM6 | PG-TDSON-8 | 046N13N6 | - |



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

| Davamatav | Cumbal | Values | | | l lmi4 | N 4 4 7 4 9 119 |
|--|-----------------------------------|-------------|-------------|------------------------|--------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Continuous drain current ¹⁾ | I _D | - - - | - - - | 142 100 92 17 | A | $V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =50 °C/W ²) |
| Pulsed drain current ³⁾ | I _{D,pulse} | - | - | 568 | Α | T _C =25 °C |
| Avalanche current, single pulse4) | I _{AS} | - | - | 50 | Α | T _C =25 °C |
| Avalanche energy, single pulse ⁴⁾ | E _{AS} | - | - | 616 | mJ | I_D =15 A, R_{GS} =25 Ω |
| Gate source voltage | V _{GS} | -20 | - | 20 | V | - |
| Power dissipation | P _{tot} | - | - | 211 3 | W | T _C =25 °C T _A =25 °C, R _{THJA} =50 °C/W ²⁾ |
| Operating and storage temperature | T _i , T _{stg} | -55 | - | 175 | °C | - |

2 Thermal characteristics

Table 3 Thermal characteristics

| Parameter | Symbol | | Values | | Unit | Note / Test Condition |
|--|-------------------|------|--------|------|------|-----------------------|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Thermal resistance, junction - case | R _{thJC} | - | - | 0.7 | °C/W | - |
| Thermal resistance, junction - case, top | R _{thJC} | - | - | 20 | °C/W | - |
| Device on PCB, 6 cm² cooling area ²⁾ | R _{thJA} | - | - | 50 | °C/W | - |

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information



3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

| Damana dan | Ol | | Values | | | | 11!4 | N |
|----------------------------------|----------------------|-------------|-------------------|-------------------|------|---|------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | | |
| Drain-source breakdown voltage | V _{(BR)DSS} | 135 | - | - | V | V _{GS} =0 V, I _D =1 mA | | |
| Gate threshold voltage | V _{GS(th)} | 2.5 | 3.0 | 3.5 | V | V _{DS} =V _{GS} , I _D =110 μA | | |
| Zero gate voltage drain current | I _{DSS} | - | 1 10 | 10 100 | μΑ | V _{DS} =108 V, V _{GS} =0 V, T _j =25 °C V _{DS} =108 V, V _{GS} =0 V, T _j =125 °C | | |
| Gate-source leakage current | I _{GSS} | - | 10 | 100 | nA | V _{GS} =20 V, V _{DS} =0 V | | |
| Drain-source on-state resistance | R _{DS(on)} | - - - | 3.7 3.9 4.2 | 4.3 4.6 5.4 | mΩ | V _{GS} =15 V, I _D =50 A V _{GS} =10 V, I _D =50 A V _{GS} =8 V, I _D =25 A | | |
| Gate resistance ¹⁾ | R _G | - | 0.7 | 1.1 | Ω | - | | |
| Transconductance ¹⁾ | g fs | 55 | 110 | - | S | $ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 50 A$ | | |

Table 5 **Dynamic characteristics**

| Parameter | Comple of | | Values | S | 11 | Nata / Tast Candition |
|--|------------------|------|--------|------|------|--|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Input capacitance ¹⁾ | Ciss | - | 4400 | 5700 | pF | V _{GS} =0 V, V _{DS} =68 V, <i>f</i> =1 MHz |
| Output capacitance ¹⁾ | Coss | - | 880 | 1100 | pF | V _{GS} =0 V, V _{DS} =68 V, <i>f</i> =1 MHz |
| Reverse transfer capacitance ¹⁾ | C _{rss} | - | 14 | 24 | pF | V _{GS} =0 V, V _{DS} =68 V, <i>f</i> =1 MHz |
| Turn-on delay time | $t_{\sf d(on)}$ | - | 15 | - | ns | $V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G,ext}$ =1.6 Ω |
| Rise time | t _r | - | 7.3 | - | ns | $V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G,ext}$ =1.6 Ω |
| Turn-off delay time | $t_{ m d(off)}$ | - | 24 | - | ns | $V_{\rm DD}$ =68 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G,ext}$ =1.6 Ω |
| Fall time | t _f | - | 7.2 | - | ns | $V_{\rm DD} = 68 \text{ V}, V_{\rm GS} = 10 \text{ V}, I_{\rm D} = 25 \text{ A}, R_{\rm G,ext} = 1.6 \Omega$ |

Gate charge characteristics²⁾ Table 6

| Davamatar | Sumb al | | Values | | | Note / Took Condition |
|-------------------------------------|----------------------|------|--------|------|------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Gate to source charge ¹⁾ | Q _{gs} | - | 19 | 25 | nC | $V_{\rm DD}$ =68 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge at threshold | Q _{g(th)} | - | 13 | - | nC | $V_{\rm DD}$ =68 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V |
| Gate to drain charge ¹⁾ | Q _{gd} | - | 13 | 19 | nC | $V_{\rm DD}$ =68 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V |
| Switching charge | Q _{sw} | - | 19 | - | nC | $V_{\rm DD}$ =68 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge total ¹⁾ | Q_g | - | 65 | 85 | nC | $V_{\rm DD}$ =68 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V |
| Gate plateau voltage | $V_{ m plateau}$ | - | 4.4 | - | V | $V_{\rm DD}$ =68 V, $I_{\rm D}$ =25 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge total, sync. FET | Q _{g(sync)} | - | 58 | - | nC | $V_{\rm DS}$ =0.1 V, $V_{\rm GS}$ =0 to 10 V |
| Output charge ¹⁾ | Qoss | - | 112 | 146 | nC | V _{DS} =68 V, V _{GS} =0 V |

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

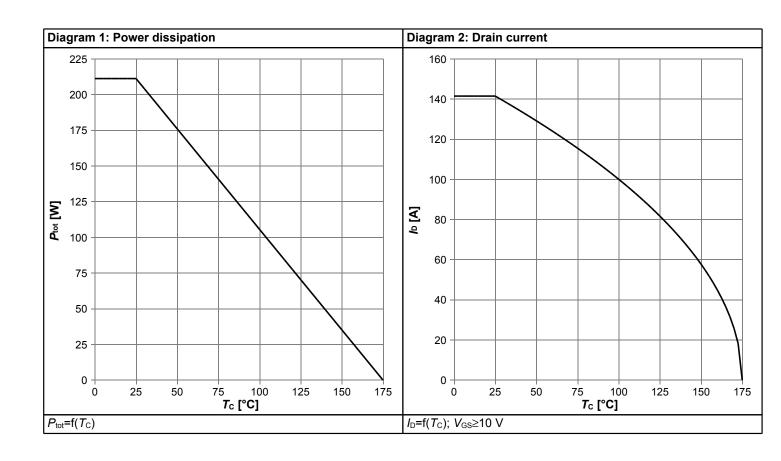


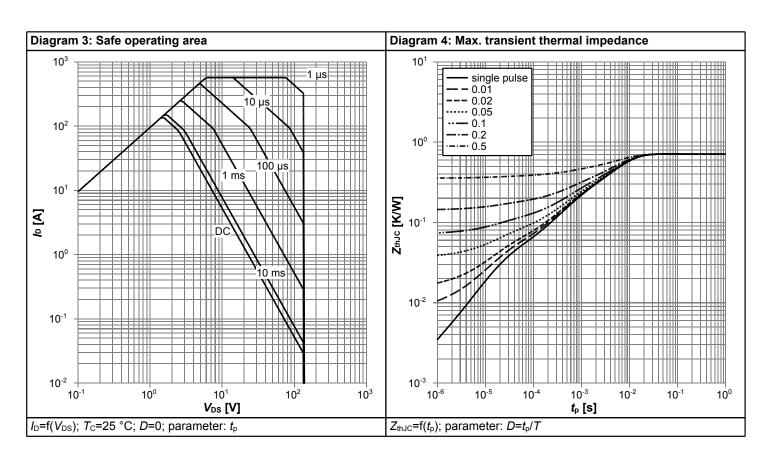
Table 7 Reverse diode

| Parameter | Cumbal | | Values | 6 | 1111111 | Note / Tost Condition |
|---------------------------------------|----------------------|------|--------|------|---------|---|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Diode continuous forward current | Is | - | - | 142 | Α | <i>T</i> _C =25 °C |
| Diode pulse current | I _{S,pulse} | - | - | 568 | Α | <i>T</i> _C =25 °C |
| Diode forward voltage | V _{SD} | - | 0.84 | 1 | V | V _{GS} =0 V, I _F =50 A, T _j =25 °C |
| Reverse recovery time ¹⁾ | t _{rr} | - | 26 | 52 | ns | V _R =68 V, I _F =25 A, d <i>i</i> _F /d <i>t</i> =500 A/μs |
| Reverse recovery charge ¹⁾ | Qrr | - | 85 | 170 | nC | V_{R} =68 V, I_{F} =25 A, di_{F}/dt =500 A/ μ s |

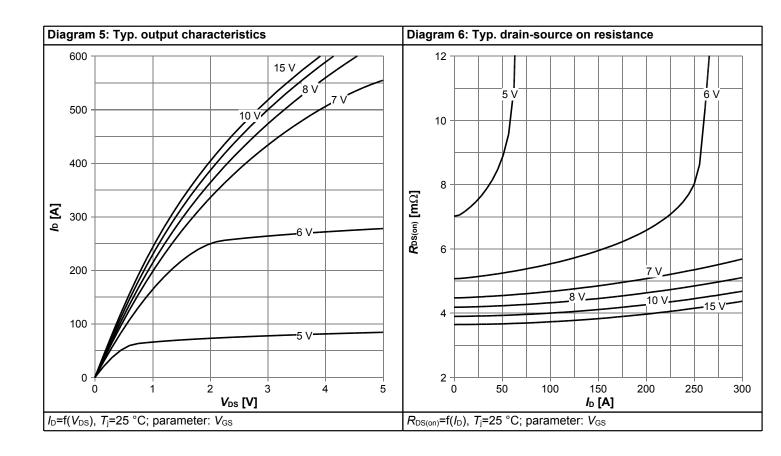


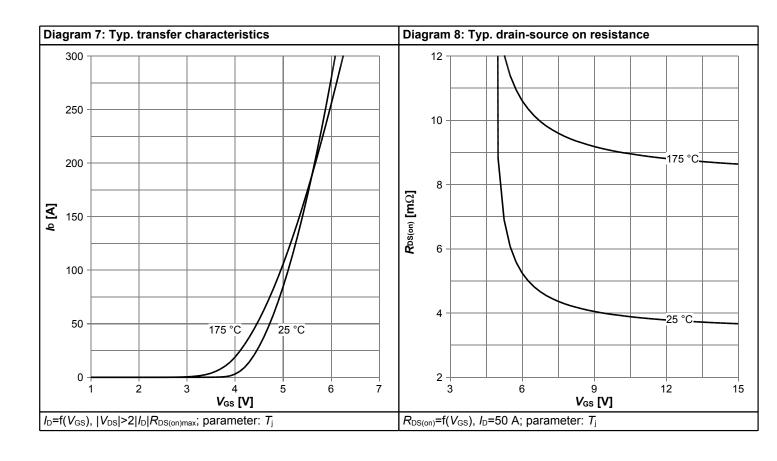
4 Electrical characteristics diagrams



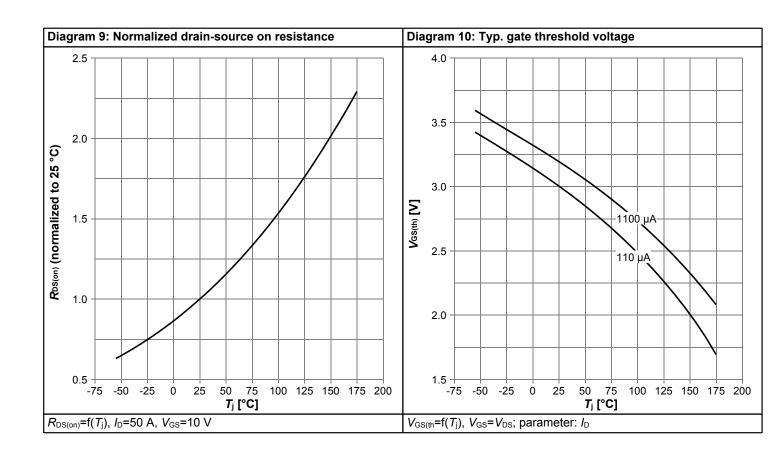


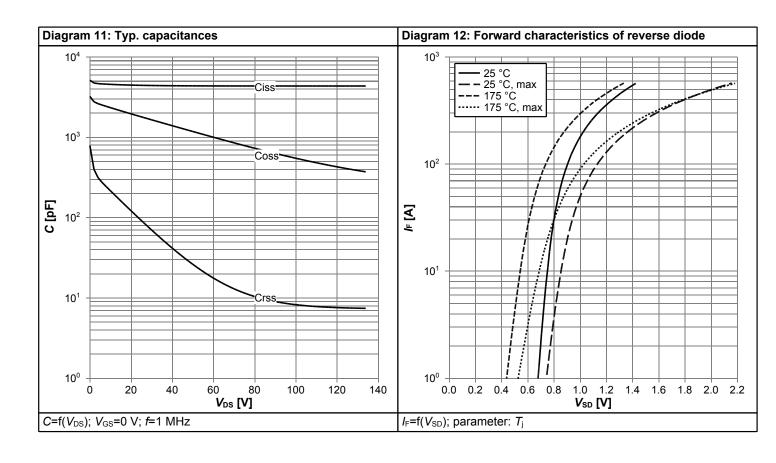




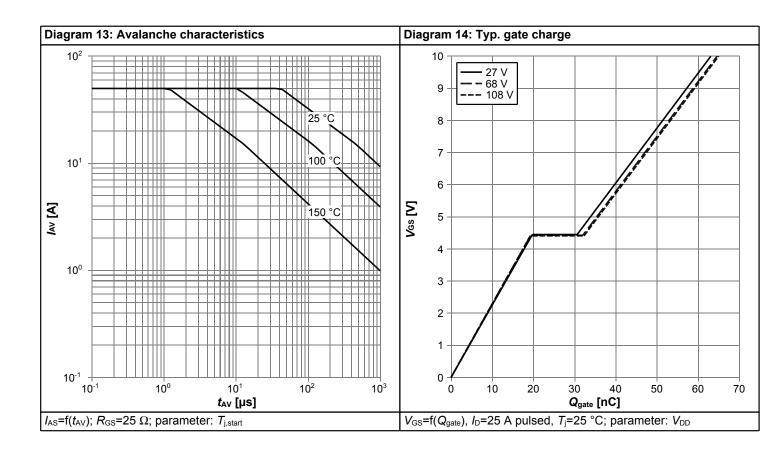


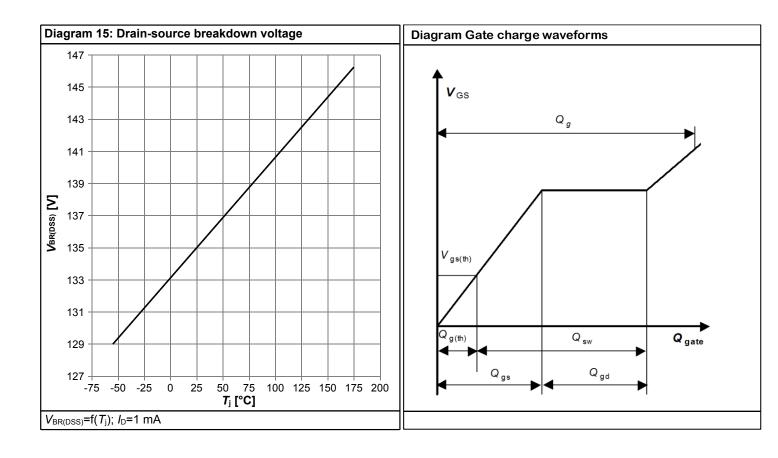






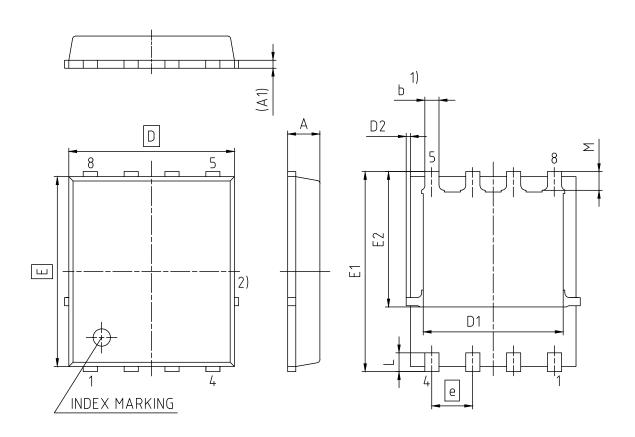








5 Package Outlines



- 1) EXCLUDING MOLD FLASH
- 2) REMOVAL ON MOLD GATE
 INTRUSION 0.1 MM
 PROTRUSION 0.1 MM
 LEAD LENGTH UP TO ANTI FLASH LINE
 ALL METAL SURFACES ARE PLATED, EXCEPT AREA OF CUT

| DIMENSION | MILLIMETERS | | | | | | |
|-----------|-------------|------|--|--|--|--|--|
| DIMENSION | MIN. | MAX. | | | | | |
| Α | 0.90 | 1.20 | | | | | |
| A1 | 0.15 | 0.35 | | | | | |
| b | 0.34 | 0.54 | | | | | |
| D | 4.80 | 5.35 | | | | | |
| D1 | 3.90 | 4.40 | | | | | |
| D2 | 0.00 | 0.22 | | | | | |
| Е | 5.70 | 6.10 | | | | | |
| E1 | 5.90 | 6.42 | | | | | |
| E2 | 3.88 | 4.31 | | | | | |
| е | 1.27 | | | | | | |
| ٦ | 0.45 | 0.71 | | | | | |
| М | 0.45 | 0.69 | | | | | |

| DOCUMENT NO. | | | | | |
|------------------------------|--|--|--|--|--|
| Z8B00003332 | | | | | |
| REVISION 08 | | | | | |
| SCALE 10:1 | | | | | |
| 0 1 2 3mm | | | | | |
| EUROPEAN PROJECTION | | | | | |
| | | | | | |
| ISSUE DATE 05.11.2019 | | | | | |

Figure 1 Outline PG-TDSON-8, dimensions in mm



Revision History

ISC046N13NM6

Revision: 2023-10-16, Rev. 2.0

Previous Revision

| 1 10 110 000 11 | 1 Toviodo (Covición | | | | | | |
|-----------------|---------------------|--|--|--|--|--|--|
| Revision | Date | Subjects (major changes since last revision) | | | | | |
| 2.0 | 2023-10-16 | Release of final version | | | | | |

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